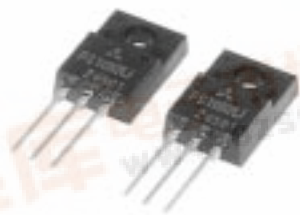


MITSUBISHI Nch POWER MOSFET

# FS10KMJ-2

HIGH-SPEED SWITCHING USE

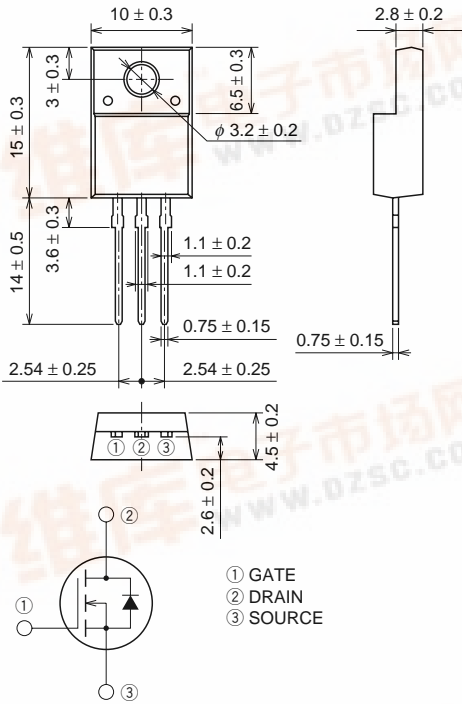
## FS10KMJ-2



- 4V DRIVE
- $V_{DS}$  ..... 100V
- $r_{DS} (ON) (MAX)$  .....  $0.19\Omega$
- $I_D$  ..... 10A
- Integrated Fast Recovery Diode (TYP.) ..... 95ns
- $V_{iso}$  ..... 2000V

## OUTLINE DRAWING

Dimensions in mm



TO-220FN

## APPLICATION

Motor control, Lamp control, Solenoid control  
DC-DC converter, etc.

## MAXIMUM RATINGS (Tc = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
$V_{DS}$	Drain-source voltage	$V_{GS} = 0V$	100	V
$V_{GSS}$	Gate-source voltage	$V_{DS} = 0V$	$\pm 20$	V
$I_D$	Drain current		10	A
$I_{DM}$	Drain current (Pulsed)		40	A
$I_{DA}$	Avalanche drain current (Pulsed)	$L = 100\mu H$	10	A
$I_S$	Source current		10	A
$I_{SM}$	Source current (Pulsed)		40	A
$P_D$	Maximum power dissipation		20	W
$T_{ch}$	Channel temperature		$-55 \sim +150$	°C
$T_{stg}$	Storage temperature		$-55 \sim +150$	°C
$V_{iso}$	Isolation voltage	AC for 1minute, Terminal to case	2000	V
—	Weight	Typical value	2.0	g

## FS10KMJ-2

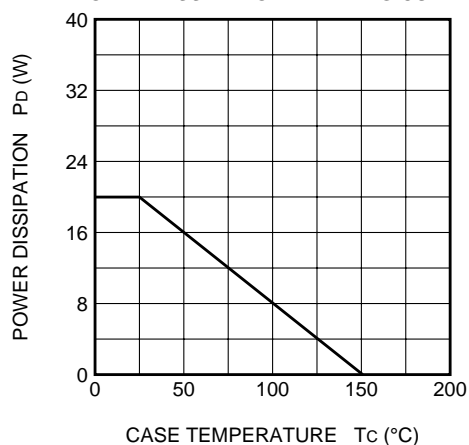
## HIGH-SPEED SWITCHING USE

ELECTRICAL CHARACTERISTICS (T<sub>ch</sub> = 25°C)

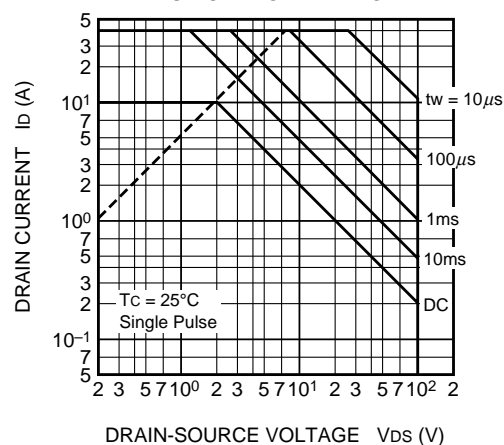
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V(BR)DSS	Drain-source breakdown voltage	I <sub>D</sub> = 1mA, V <sub>GS</sub> = 0V	100	—	—	V
I <sub>GSS</sub>	Gate-source leakage current	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V	—	—	±0.1	μA
I <sub>DSS</sub>	Drain-source leakage current	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V	—	—	0.1	mA
V <sub>GS(th)</sub>	Gate-source threshold voltage	I <sub>D</sub> = 1mA, V <sub>DS</sub> = 10V	1.0	1.5	2.0	V
r <sub>DS(ON)</sub>	Drain-source on-state resistance	I <sub>D</sub> = 5A, V <sub>GS</sub> = 10V	—	0.14	0.19	Ω
r <sub>DS(ON)</sub>	Drain-source on-state resistance	I <sub>D</sub> = 5A, V <sub>GS</sub> = 4V	—	0.16	0.21	Ω
V <sub>DS(ON)</sub>	Drain-source on-state voltage	I <sub>D</sub> = 5A, V <sub>GS</sub> = 10V	—	0.70	0.95	V
y <sub>fs</sub>	Forward transfer admittance	I <sub>D</sub> = 5A, V <sub>DS</sub> = 5V	—	13	—	S
C <sub>iss</sub>	Input capacitance	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1MHz	—	800	—	pF
C <sub>oss</sub>	Output capacitance		—	125	—	pF
C <sub>rss</sub>	Reverse transfer capacitance		—	45	—	pF
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 50V, I <sub>D</sub> = 5A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = R <sub>GS</sub> = 50Ω	—	14	—	ns
t <sub>r</sub>	Rise time		—	15	—	ns
t <sub>d(off)</sub>	Turn-off delay time		—	65	—	ns
t <sub>f</sub>	Fall time		—	40	—	ns
V <sub>SD</sub>	Source-drain voltage	I <sub>S</sub> = 5A, V <sub>GS</sub> = 0V	—	1.0	1.5	V
R <sub>th(ch-c)</sub>	Thermal resistance	Channel to case	—	—	6.25	°C/W
t <sub>rr</sub>	Reverse recovery time	I <sub>S</sub> = 10A, di <sub>s</sub> /dt = -100A/μs	—	95	—	ns

## PERFORMANCE CURVES

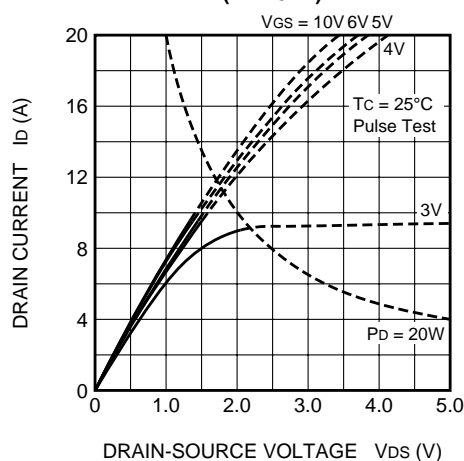
POWER DISSIPATION DERATING CURVE



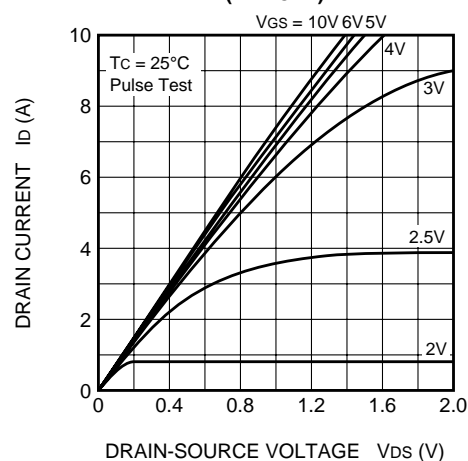
MAXIMUM SAFE OPERATING AREA



OUTPUT CHARACTERISTICS (TYPICAL)

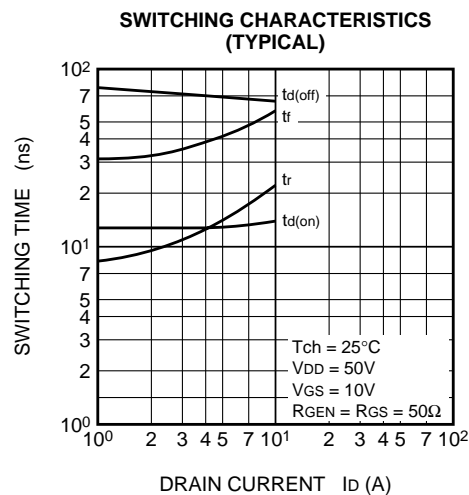
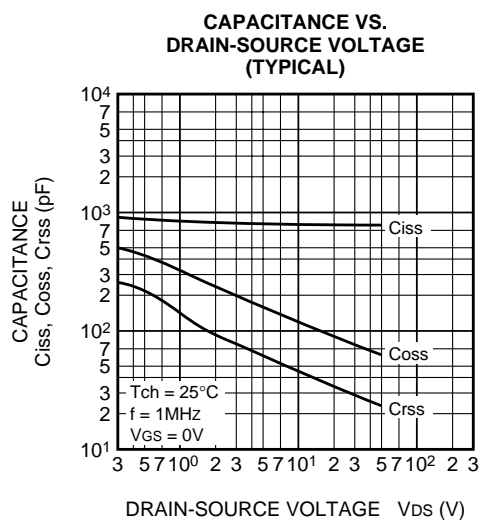
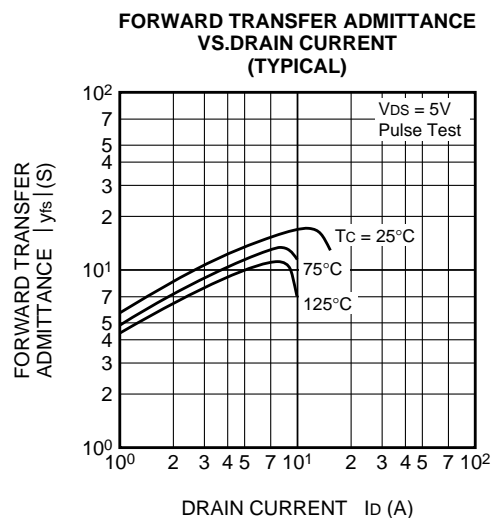
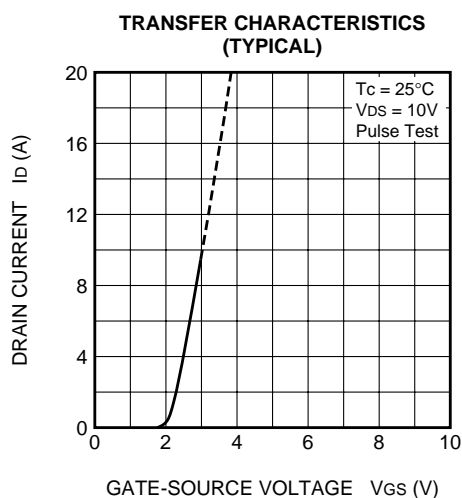
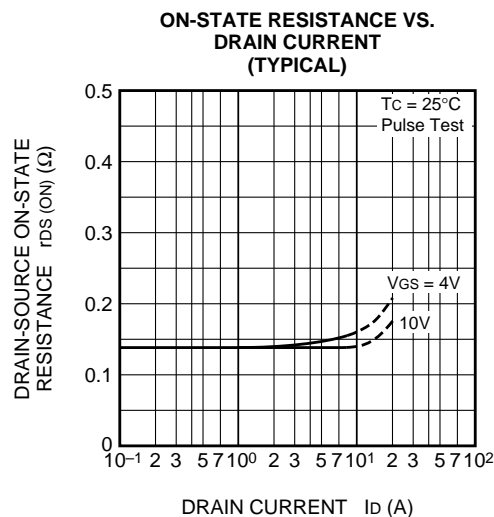
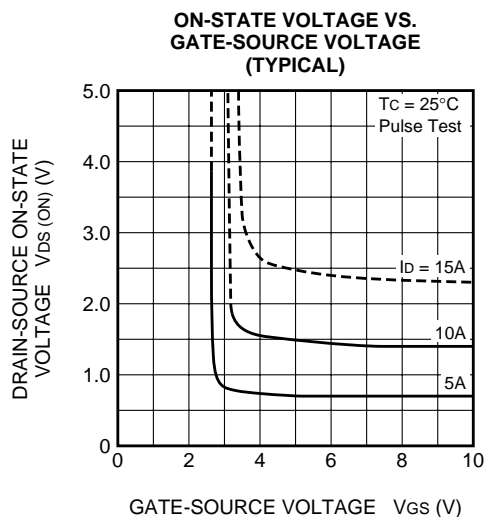


OUTPUT CHARACTERISTICS (TYPICAL)



# FS10KMJ-2

## HIGH-SPEED SWITCHING USE



# FS10KMJ-2

HIGH-SPEED SWITCHING USE

